

Product Overview

The NSA9260 is a highly integrated and AEC-Q100 qualified IC for automotive bridge sensor conditioning. The NSA9260 integrates an instrumentation PGA, a 24-bit ADC for primary signal measurement channel, a 24-bit ADC for temperature measurement channel and sensor calibration logic. With the calibration algorithm built in the internal MCU, the NSA9260 supports to compensate sensor offset, sensitivity, temperature drift up to 2nd order, and non-linearity up to the 3rd order. The calibration coefficients are stored in a 64-Byte EEPROM that can be programmed multiple times. The NSA9260 also supports Over-voltage and Reverse-voltage protection. It can provide analog output and PWM output. It can also support sensor diagnosis.

Key Features

- Over-voltage and Reverse-voltage protection between -24V ~ 28V
- Voltage supply up to 36V with an external JFET
- Directly high voltage supply up to 18V
- Instrumentation amplifier with programmable gain from 1X to 256X
- 1X~8X ADC digital gain
- 24-bit ADC for primary signal measurement
- 24-bit ADC for temperature measurement
- Sensor connection fault detection supported
- Internal and external temperature sensor supported
- Low temperature drift 16-bit DAC
- A pair of constant current sources
- Sensor calibration algorithm embedded in a built-in MCU
- 64-Bytes EEPROM
- Ratiometric or absolute voltage output
- PWM output supported
- Specific OWI interface
- SSOP16 package

- Qualified according to AEC-Q100 Grade 0
- Operation temperature: -40°C~150°C
- RoHS & REACH compliance

Applications

- Resistive Pressure sensors
- Automotive air-conditioner
- Oil Pressure sensors
- Pneumatic pressure sensors
- Hydraulic pressure sensors

Device Information

Part Number	Package	Body Size
NSA9260	SSOP16	5mm × 6mm

Functional Block Diagrams

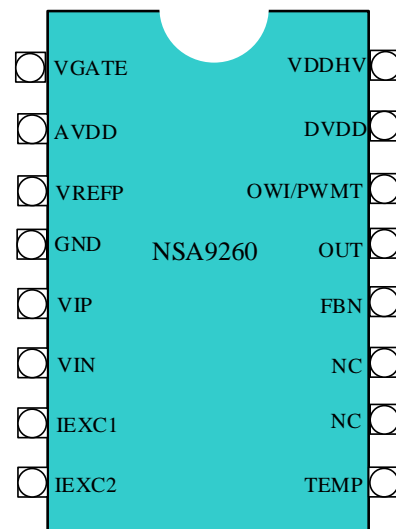


Figure 1. NSA9260 Pin Diagram

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1. Pin Configuration and Functions

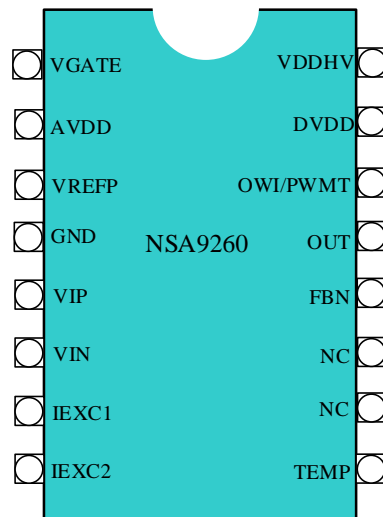


Figure 1.1 NSA9260 Pin Diagram

Table 1.1 NSA9260 Pin Configuration and Description

PIN No.	Symbol	Function
1	VGATE	JFET controller output
2	AVDD	Internal analog power supply
3	VREFP	Internal reference voltage VREF output/External reference voltage input (set by register 0xA2)
4	GND	Ground
5	VIP	Positive analog input
6	VIN	Negative analog input
7	IEXC1	1 st constant current source
8	IEXC2	2 nd constant current source/External bias resistor
9	TEMP	External temperature sensor input
10	NC	Floating
11	NC	Floating
12	FBN	Output driver feedback
13	OUT/PWMDAC	Driver output or DAC PWM output
14	OWI/PWMT	One-wire interface or Temperature channel PWM output
15	DVDD	1.8V digital supply from internal LDO
16	VDDHV	Power supply with OVP/RVP

2. Absolute Maximum Ratings

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Supply Voltage	VDDHV _{max}	-24		28	V	70°C, 1 hour
		-30		36	V	70°C, 1 minute
AVDD	AVDD _{max}			6.5	V	
Analog Pin Voltage		-0.3		AVDD+0.3	V	
Analog Output Current Limit				25	mA	
Digital Pin Voltage		-0.3		AVDD+0.3	V	25°C
Maximum Junction Temperature	T _{jmax}			155	°C	
Storage Temperature		-60		150	°C	
Operation Temperature	T _{A_EXT}	-40		150	°C	

3. ESD Rating

	Ratings	Value	Unit
Electrostatic discharge	Human body model (HBM), per AEC-Q100-002 Rev E <ul style="list-style-type: none"> All other pins to AVDD/VDDHV All other pins to GND IO pins to IO pins 	±2	kV
	Charged device model (CDM), per AEC-Q100-011 Rev D <ul style="list-style-type: none"> All pins 	±750	V

4. Electrical Characteristics

4.1. Electrical Characteristics

Typical conditions: VDDHV = 5V; Temperature = 25°C.

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Supply Voltage Range	VDDHV	4.5	5	5.5	V	REG_LVL=0
		5.5		18	V	REG_LVL=1
AVDD Output	AVDD		VDDHV-0.02		V	Supply on VDDHV pin REG_LVL=0
			5.2			Supply on VDDHV pin REG_LVL=1
DVDD Output	DVDD	1.7	1.8	1.85	V	

Power on Reset	V _{POR_AVDD}		2.5		V	POR threshold during power-up
	V _{POR_HYS}		0.1		V	POR threshold hysteresis
Operation Current	I _{avdd2}		1.7		mA	0~5V output without resistive load (DAC_ON = 1)
Reference Voltage and Current Source						
Internal Bandgap Reference	VBG	1.119	1.2	1.201	V	Can not measure directly, proportional with VREF
VBG TC	VBG_TC		5	20	ppm/°C	-40°C~125°C
VREF Output	VREF	4 or 2.5			V	VREF_DIS = 0
Input Current when VREF Driven Externally	I_VREF_EXT	-10		10	nA	VREF_DIS = 1
Load on VREF	RVREF	0.5			kohm	
VREF Current Limit	IVREF_limit		20		mA	Short to Ground
Current Source Outputs with Internal Reference Resistor	IEXC1	0		750	μA	50μA/Step
	IEXC2	0		700	μA	50μA/Step, when IEXC2<3:0> ≠ 4'b1111
External Reference Resistor for Constant Current	R _{IEXC}	20	25	33	kohm	When IEXC2<3:0> = 4'b1111
IEXC Temperature Drift (Internal Reference Resistor)	I _{EXC_TC}		40	120	ppm/°C	
IEXC1/2 Mismatch				1%		When IEXC1<3:0> = IEXC2<3:0> = 4'b0100~0111
Headroom Voltage for Current Sources		0		AVDD-0.8	V	
Primary Signal Measurement Channel						
PGA Gain	GAIN	1		256		
PGA Gain Error	GAINP_ERR			0.1%		GAIN = 32
PGA Gain TC Drift	GAINP_TC		3		ppm/°C	-40°C~120°C, GAIN = 32X, VREF = 4V, SYSTEM_CHOP_EN = 1
Offset Error	OFF			600/GAIN	μV	Input referred, SYSTEM_CHOP_EN = 0
				1	μV	Input referred, SYSTEM_CHOP_EN = 1
Offset TC	OFF_DRIFT		±5		nV/°C	Input referred, SYSTEM_CHOP_EN = 1
PADC Resolution	RESRAW		24		Bits	
PADC Output Data Rate	ODR_P	5		4800	Hz	
ENOB of Primary Channel	ENOB_P	Refer to Table 6.1			Bits	Depends on PGA_P GAIN and ODR_P
Integral Nonlinearity	INL			15	ppm	

					of FS		
Input CMRR of Primary Channel	CMRR		120		dB		
PSRR of Primary Channel	PSRR	90	120		dB		
Temperature Measurement Channel (Internal and External Temperature Sensor)							
TADC Resolution	RES_T		24		Bit		
TADC Gain	GAIN_T	1		4		1, 2, 4	
TADC Output Data Rate	ODR_T	5		4800	Hz		
TADC ENOB	ENOB_T	Refer to Table 6.3					Depend on ODR_T or PGA_T GAIN
Error of Internal Temperature Sensor			± 1.5	± 3	$^{\circ}\text{C}$	-40~125 $^{\circ}\text{C}$	
TEMP Input Impedance			1		Gohm		
Analog Input Pins							
Input Pin Voltage	VIP, VIN	GND+0.4		AVDD-1.2	V	PGA on (Gain>2)	
		GND+0.1		AVDD-0.1	V	PGA off, Buffer on	
		GND-0.1		AVDD+0.1	V	PGA off, Buffer off	
Differential Input Signal Range	V _{range}		$\pm \text{VREF}/\text{GAIN}$		V	VREF is the ADC reference voltage	
VINP, VINN Input Pins Leakage Current	I _{leakage}			± 1	nA	DIAG_ON = 0	
DAC and Output Buffer							
DAC Resolution			16		Bit		
DAC Full Scale	VFSDAC	5V, 3.3V, 1.2V or Ratiometric					Depends on DAC_REF<1:0>
DNL of DAC	DNL			1	LSB		
INL of DAC	INL			10	LSB		
DAC Output RMS noise	V _{rms}		0.5		mV		
Output Load Resistance	R _{load}	1			kohm		
Output Load Capacitance	C _{load}			150	nF		
Output Shorted Current Limit	I _{short_lmt}	10		25	mA	Output Short to VDD or GND	
Clamp High Level	V _{clamph}	0.5		1	VFSDAC	Set by CLAMP_HIGH<7:0>	
Clamp Low Level	V _{clampl}	0		0.5	VFSDAC	Set by CLAMP_LOW<7:0>	
Diagnostic and Alarm							
Burnout Current	I _{diag}		100		nA		
Fault Alarm High	FAULT_HIGH	98%			VDD		
Fault Alarm Low	FAULT_LOW			2%	VDD		
Diagnostic Response Time	T _{diag}			1	ms		
OSC							

ADC Clock	FOSC_MOD		1.2		MHz	
Clock Rate Error	FOSC_ERR	-1%		1%		-40~125°C
PWM						
PWM Frequency	FPWM		600		Hz	
PWM Resolution	RPWM		12		Bit	
EEPROM						
Programming Temperature	T _{EEP}	-40		105	°C	
Programming Supply Voltage	VEE	4.5		5.5	V	
Time for EEPROM Programming	T _{EEP}		0.8		s	
Endurance			10k			
Date Retention		10			A	@150°C
Serial Interface						
OWI Bit Period	T _{owi}	0.03		4	ms	
OWI Pull-up Resistance	R _{owi_pu}	300			ohm	

5. Register Description

The register map of the NSA9260 includes two parts, normal registers and EEPROM registers. The normal registers include data registers and some control registers, while the EEPROM registers are mainly configuration registers and calibration coefficients. All EEPROM registers should be written by external interface on command mode (register 'CMD' = '0x00').

5.1. Normal Registers

IF_CTRL (R/W)

Addr	Bit	Register Name	Default	Description
0x00	5, 2	SOFTRESET	1'b0	Set either of these two bits to 1 to reset the chip. Return to 0 after reset

STATUS (Read Only)

Addr	Bit	Register Name	Default	Description
0x02	7 - 3	ERROR_CODE<4:0>	5'b00000	Code error: Bit6=1: VIP open or VREF short; Bit5=1: VIP short to GND; Bit4=1: VIN open or short to VREF; Bit3=1: VIN short to GND
	2	CRC_ERR	1'b0	1: CRC error detected during EEPROM loading; When CRC error is asserted, EEPROM register bits 'OWI_DIS', 'OWI_AC_EN', 'OWI_WINDOW', 'JFET_DIS', 'VREF_DIS', 'EEPROM_LOCK' are forced to 0.
	1	LOADING_END	1'b0	1: EEPROM loading end flag
	0	DRDY	1'b0	1: Set after a new data updated and automatically cleared after a register reading to PDATA/TDATA or before the next data's coming

PDATA (Read Only, Primary Channel Data Register)

Addr	Bit	Register Name	Default	Description
0x06	7 - 0	PDATA<23:16>	0x00	Signed, 2's complement: When 'RAW_P' = 1, store the ADC output of primary channel; When 'RAW_P' = 0, store the calibrated primary channel data.
0x07	7 - 0	PDATA<15:8>	0x00	
0x08	7 - 0	PDATA<7:0>	0x00	

TDATA (Read Only, Temperature Channel Data Register)

Addr	Bit	Register Name	Default	Description
0x09	7 - 0	TDATA<23:16>	0x00	Signed, 2's complement: When 'RAW_T' = 1, store the ADC output of temperature channel; When 'RAW_T' = 0, store the calibrated temperature data, LSB = $1/2^{16}^{\circ}\text{C}$. Real Temperature = $\text{TDATA}/2^{16}+25^{\circ}\text{C}$
0x0a	7 - 0	TDATA<15:8>	0x00	
0x0b	7 - 0	TDATA<7:0>	0x00	

DAC_DATA (R/W, DAC Input Data Register)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0x12	7 – 0	DAC_DATA<15:8>	0x00	DAC input data, unsigned; When 'RAW_P' = 0, set by the internal calibration logic, read only; When 'RAW_P' = 1, set externally through serial interface.
0x13	7 – 0	DAC_DATA<7:0>	0x00	
0x14	0	DAC_BLANK	1'b0	Blank DAC input update when 'RAW_P' = 1, should be set before writing DAC_MSB and DAC_LSB and cleared after writing finished.

COMMAND (R/W, Command Register)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0x30	7 – 0	CMD<7:0>	0x03	0x00: Command mode, all EEPROM can be written only in command mode; 0x03: Active mode; 0x33: Enter EEPROM program mode.

QUIT_OWI (Write Only)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0x61	7 – 0	QUIT_OWI <7:0>	0x00	Write '0x5D' to this register to quit OWI communication. If 'QUIT_OWI_CNT' = 0x00, quit OWI communication permanently; If 'QUIT_OWI_CNT' is not 0x00, quit OWI mode temporarily with a certain time and then get back to OWI mode.

QUIT_OWI_CNT (R/W)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0x62	7 – 0	QUIT_OWI_CNT<7:0> >	0x00	Time for temporarily quit OWI communication Mode. 0x00: Quit forever, 0x01: 50ms, 0x02: 100ms ... 0xFF: 12.8s

EE_PROG (R/W)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0x6a	7 – 0	EE_PROG<7:0>	0x00	Write '3E' to this register to start EEPROM Programming. Automatically cleared to '0x00' after programming finished.

VDD_CHECK (R/W)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0x70	0	VDD_CHECK	1'b0	Write '1' to force AVDD/2 as the input of temperature ADC.

5.2. EEPROM Registers

SYS_CONFIG1 (R/W)

Addr	Bit	Register Name	Default	Description
0xa1	7	CAL_MODE	1'b0	0: One segment calibration with the 2 nd order temperature coefficients; 1: Two segment calibration with the 1 st order temperature coefficients
	6	BURNOUT_EN	1'b0	1: Enable the 100nA burnout current sources
	5	FAULT_ON	1'b0	1: When any fault is detected, pull analog output to a fixed-level voltage
	4	FAULT_LVL	1'b0	1: High alarm output; 0: Low alarm output
	3	OWI_PUSHPULL	1'b0	0: OWI is open-drain with the need of pull-up resistor during communication; 1: OWI is push-pull without the need of pull-up resistor
	2	RESERVED	1'b0	RESERVED
	1	OWI_DIS	1'b0	1: OWI disabled (won't be effective until next power on reset or soft reset after EEPROM is programmed)
	0	RESERVED	1'b0	RESERVED

SYS_CONFIG2 (R/W)

Addr	Bit	Register Name	Default	Description
0xa2	7	JFET_DIS	1'b0	1: Disable JFET regulator
	6	JFET_LVL	1'b0	0: VDDHV Over-voltage clamp value is 6.0V; AVDD output 5V during JFET power supply; 1: VDDHV Over-voltage clamp value is 5.2V; AVDD output 3.3V during JFET power supply
	5	VREF_DIS	1'b0	1: Disable reference buffer, and reference voltage can be forced externally
	4	VREF_LVL	1'b0	0: VREF = 4V; 1: VREF = 2.5V
	3	T_OUT_EN	1'b0	1: When not in OWI mode, TADC data outputs through OWI pin in PWM format
	2 - 0	OUT_MODE<2:0>	3'b000	000: Voltage output with external feedback; 001: Voltage output with internal feedback; 010/011/100: Reserved; 101: DAC PWM output; 110: Reserved, should not be used; 111: Disable DAC.

Current_EXC (R/W)

Addr	Bit	Register Name	Default	Description
0xa3	7 – 4	IEXC1<3:0>	4'b0000	IEXC1/2: set IEXC1 and IEXC2 current value or mode; 0000: Disabled; 0001: 50µA; 0010: 100µA;
	3 – 0	IEXC2<3:0>	4'b0000	... 1111 for IEXC1: 750µA; 1111 for IEXC2: use external reference resistor.

PCH_Config1 (R/W)

Addr	Bit	Register Name	Default	Description
0xa4	7 – 4	GAIN_P<3:0>	4'b0000	Primary Channel Gain 0000: 1X, 0001: 2X, 0010: 4X, 0011: 6X, 0100: 8X, 0101: 12X, 0110: 16X, 0111: 24X, 1000: 32X, 1001: 48X, 1010: 64X, 1011: 96X, 1100: 128X, 1101: 192X, 1110: 256X, 1111: 1X and disable buffer.
	3 – 0	ODR_P<3:0>	4'b0000	PADC output data rate setting 0000: 4.8kHz, 0001: 2.4kHz, 0010: 1.2kHz, 0011: 600Hz, 0100: 300Hz, 0101: 150Hz, 0110: 75Hz, 0111: 37.5Hz, 1000: 20Hz (with 60Hz notch), 1001: 20Hz (with 50Hz notch), 1010: 10Hz (with 60Hz notch), 1011: 10Hz (with 50Hz notch), 1100: 5Hz (with 60Hz notch), 1101: 5Hz (with 50Hz notch) 1110, 1111: PADC disabled

PCH_Config2 (R/W)

Addr	Bit	Register Name	Default	Description
0xa5	7 – 6	DAC_REF<1:0>	2'b00	DAC full scale reference 00: 5V, 01: 3.3V, 10: 1.2V, 11: AVDD (ratiometric)
	5 – 3	RESERVED<2:0>	3'b000	Should be 3'b000
	2	SYS_CHOP_EN	1'b0	0: Disable system chopping; 1: Enable system chopping
	1	INPUT_SWAP	1'b0	1: Swap the polarity of inputs of PADC
	0	RAW_P	1'b0	0: Update calibrated sensor data into 'PDATA' register. 'DAC_DATA' will be set by internal calibration logic; 1: Update raw primary ADC data into 'PDATA' register after conversion, and allow DAC to be set externally

TCH_Config (R/W)

Addr	Bit	Register Name	Default	Description
0xa6	7	EXT_TEMP	1'b0	0: Internal temperature sensor selected; 1: External temperature sensor selected (TEMP pin as external temperature sensor input)
	6 – 5	GAIN_T<1:0>	2'b00	Gain for External temperature sensors 00: 1X, 01: 2X, 10/11: 4X (only 4x for internal temperature)
	4 – 1	ODR_T	4'b0000	TADC output data rate, similar as ODR_P 0000: 4.8kHz, 0001: 2.4kHz, 0010: 1.2kHz, 0011: 600Hz, 0100: 300Hz, 0101: 150Hz, 0110: 75Hz, 0111: 37.5Hz, 1000: 20Hz (with 60Hz notch), 1001: 20Hz (with 50Hz notch), 1010: 10Hz (with 60Hz notch), 1011: 10Hz (with 50Hz notch), 1100: 5Hz (with 60Hz notch), 1101: 5Hz (with 50Hz notch), 1110, 1111: TADC disabled
	0	RAW_T	1'b0	1: Store the raw TADC output into 'TDATA' register; 0: Store the calibrated TADC data into 'TDATA' register

CLAMPH (R/W) S

Addr	Bit	Register Name	Default	Description
0xa7	7 – 0	CLAMPH<7:0>	0x00	Set clamping high level, $(1 - \text{CLAMPH} * 2^{(-9)}) * \text{VFSDAC}$

CLAMPL (R/W)

Addr	Bit	Register Name	Default	Description
0xa8	7 – 0	CLAMPL<7:0>	0x00	Set clamping low level, $\text{CLAMPL} * 2^{(-9)} * \text{VFSDAC}$

OFFSET0 (R/W)

Addr	Bit	Register Name	Default	Description
0xa9	7 – 0	OFF0<15:8>	0x00	Sensor calibration coefficient, offset at T0. LSB = $1/2^{15}$, RANGE (-1, +1)
0xaa	7 – 0	OFF0<7:0>	0x00	

CTC1 (R/W)

Addr	Bit	Register Name	Default	Description
0xab	7 – 0	CTC1<15:8>	0x00	Sensor calibration coefficient, CAL_MODE = 0: the 1 st order temperature coefficient of offset. LSB = $1/2^{22}$, RANGE (-0.00781, +0.00781); CAL_MODE = 1: the 1 st order temperature coefficient of offset for segment 0. LSB = $1/2^{22}$, RANGE (-0.00781, +0.00781)
0xac	7 – 0	CTC1<7:0>	0x00	

CTC2 (R/W)

Addr	Bit	Register Name	Default	Description
0xad	7-0	CTC2<15:8>	0x00	Sensor calibration coefficient, CAL_MODE = 0: the 2 nd order temperature coefficient of offset. LSB = 1/2 ²⁹ , RANGE (-6.1e-5, 6.1e-5); CAL_MODE = 1: the 1 st order temperature coefficient of offset for segment 1. LSB = 1/2 ²² , RANGE (-0.00781, +0.00781)
0xae	7-0	CTC2<7:0>	0x00	

S0 (R/W)

Addr	Bit	Register Name	Default	Description
0xaf	7-0	S0<15:8>	0x00	Sensor calibration coefficient, sensitivity at T0. LSB = 1/2 ¹⁵ (unsigned), RANGE (0, 2)
0xb0	7-0	S0<7:0>	0x00	

STC1 (R/W)

Addr	Bit	Register Name	Default	Description
0xb1	7-0	STC1<15:8>	0x00	Sensor calibration coefficient, CAL_MODE = 0: the 1 st order temperature coefficient of sensitivity. LSB = 1/2 ²² , RANGE (-0.00781, +0.00781); CAL_MODE = 1: the 1 st order temperature coefficient of sensitivity for segment 0. LSB = 1/2 ²² , RANGE (-0.00781, +0.00781)
0xb2	7-0	STC1<7:0>	0x00	

STC2 (R/W)

Addr	Bit	Register Name	Default	Description
0xb3	7-0	STC2<15:8>	0x00	Sensor calibration coefficient, CAL_MODE = 0: the 2 nd order temperature coefficient of sensitivity. LSB = 1/2 ²⁹ , RANGE (-6.1e-5, 6.1e-5); CAL_MODE = 1: the 1 st order temperature coefficient of sensitivity for segment 1. LSB = 1/2 ²² , RANGE (-0.00781, +0.00781)
0xb4	7-0	STC2<7:0>	0x00	

KS (R/W)

Addr	Bit	Register Name	Default	Description
0xb5	7-0	KS<15:8>	0x00	Sensor calibration coefficient, the 2 nd order nonlinearity coefficient. LSB = 1/2 ¹⁵ , RANGE (-1, +1)
0xb6	7-0	KS<7:0>	0x00	

KSS (R/W)

Addr	Bit	Register Name	Default	Description
0xb7	7-0	KSS<15:8>	0x00	Sensor calibration coefficient, the 3 rd order nonlinearity coefficient. LSB = 1/2 ¹⁶ , RANGE (-0.5, +0.5)
0xb8	7-0	KSS<7:0>	0x00	

SCALE_OFF (R/W)

Addr	Bit	Register Name	Default	Description
0xb9	7-0	SCALE_OFF<23:16>	0x00	SCALE offset coefficient, LSB = $1/2^{23}$, RANGE (-1, +1)
0xba	7-0	SCALE_OFF<15:8>	0x00	
0xbb	7-0	SCALE_OFF<7:0>	0x00	

SCALE_S (R/W)

Addr	Bit	Register Name	Default	Description
0xbc	7-0	SCALE_S<23:16>	0x00	SCALE sensitivity coefficient (unsigned), LSB = $1/2^{16}$ (unsigned), RANGE (0, 256)
0xbd	7-0	SCALE_S<15:8>	0x00	
0xbe	7-0	SCALE_S<7:0>	0x00	

T0 (R/W)

Addr	Bit	Register Name	Default	Description
0xbf	7-0	T0<7:0>	0x00	Sensor calibration coefficient, reference temperature point, real reference temperature, REAL_T0 = T0 + 25. LSB = 1, RANGE (-128, +127)

KTS (R/W)

Addr	Bit	Register Name	Default	Description
0xc0	7-0	KTS<7:0>	0x00	Sensor calibration coefficient, the 2 nd order nonlinearity coefficient for external temperature sensor. LSB = $1/2^7$, RANGE (-1, +1)

MTO (R/W)

Addr	Bit	Register Name	Default	Description
0xc1	7-0	MTO<15:8>	0x00	Sensor calibration coefficient, offset coefficient of external temperature sensor, MTO: LSB = $1/2^{15}$, RANGE (-1, +1)
0xc2	7-0	MTO<7:0>	0x00	

KT (R/W)

Addr	Bit	Register Name	Default	Description
0xc3	7-0	KT<15:8>	0x00	Sensor calibration coefficient: sensitivity coefficient of external temperature sensor, KT: LSB = $1/2^{12}$, RANGE (-8, +8)
0xc4	7-0	KT<7:0>	0x00	

DAC_OFF (R/W)

Addr	Bit	Register Name	Default	Description
0xc5	7-0	DAC_OFF<15:8>	0xXX	DAC calibration coefficient: DAC offset LSB = $1/2^{15}$, RANGE (-1, +1), written by NOVOSENSE after calibration at factory, should not be changed unless necessary
0xc6	7-0	DAC_OFF<7:0>	0xXX	

DAC_GAIN (R/W)

Addr	Bit	Register Name	Default	Description
0xc7	7-0	DAC_GAIN<15:8>	0xXX	DAC calibration coefficient: DAC gain coefficient, LSB = $1/2^{16}$, RANGE (-0.5, +0.5), written by NOVOSENSE after calibration at factory, should not be changed unless necessary
0xc8	7-0	DAC_GAIN<7:0>	0xXX	

PADC_OFF (R/W)

Addr	Bit	Register Name	Default	Description
0xc9	7-0	PADC_OFF<23:16>	0x00	PADC calibration coefficient: PADC offset, LSB = $1/2^{23}$, RANGE (-1, +1)
0xca	7-0	PADC_OFF<15:8>	0x00	
0xcb	7-0	PADC_OFF<7:0>	0x00	

PADC_GAIN (R/W)

Addr	Bit	Register Name	Default	Description
0xcc	7-0	PADC_GAIN<15:8>	0x00	PADC calibration coefficient: PADC gain, LSB = $1/2^{16}$, RANGE (-0.5, +0.5)
0xcd	7-0	PADC_GAIN<7:0>	0x00	

P0 (R/W)

Addr	Bit	Register Name	Default	Description
0xce	7-0	P0 <7:0>	0x00	Sensor calibration coefficient: reference pressure point for nonlinearity calibration, LSB = $1/2^7$, RANGE (-1, 1)

SPARE (R/W)

Addr	Bit	Register Name	Default	Description
0xcf	7-0	SPARE1<7:0>	0x00	SPARE Register 1
0xd0	7-0	SPARE2<7:0>	0x00	SPARE Register 2
0xd1	7-0	SPARE3<7:0>	0x00	SPARE Register 3
0xd2	7-0	SPARE4<7:0>	0x00	SPARE Register 4
0xd3	7-0	SPARE5<7:0>	0x00	SPARE Register 5
0xd4	7-0	SPARE6<7:0>	0x00	SPARE Register 6
0xd5	7-0	SPARE7<7:0>	0x00	SPARE Register 7
0xd6	7-0	SPARE8<7:0>	0x00	SPARE Register 8

DIG_GAIN (R/W)

Addr	Bit	Register Name	Default	Description
0xd7	7-6	DIG_GAIN<1:0>	2'b00	Digital Gain Setting 00: 1X, 01: 2X, 10: 4X, 11: 8X
	5-0	RESERVED	6'b000000	RESERVED

RESERVED

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0xd8	7-0	RESERVED	-	For NOVOSENSE INFO,customer should not erase these bits

EEPROM_LOCK (R/W)

<i>Addr</i>	<i>Bit</i>	<i>Register Name</i>	<i>Default</i>	<i>Description</i>
0xd9	7	EEPROM_LOCK	1'b0	1: EEPROM lock, set 1 and then EEPROM can't be programmed (Won't be effective until next power on reset or soft reset after EEPROM is programmed).
	6 - 0	PARTID (read only)	7'b0000100	NOVOSENSE chip ID,customer should not erase these bits

6. Function Description

6.1. Overview

The NSA9260 is a highly integrated and AEC-Q100 qualified sensor conditioner for automotive bridge sensor conditioning. The chip supports Over-voltage and Reverse-voltage protection, as well as direct high-voltage power supply or high-voltage power supply through an external JFET. Analog output and PWM output are both available. The chip consists of five parts: the analog front-end module, the digital module, the analog output module, the power supply module and the serial interface. The block diagram of the NSA9260 is shown in Figure 6.1.

The analog front-end module includes a primary signal measurement channel with an instrumentation amplifier followed by a 24-bit $\Sigma\Delta$ ADC, a temperature measurement channel with also a 24-bit $\Sigma\Delta$ ADC, for precise sensor signal measurement.

The digital module is composed of registers, EEPROM, control logic, and a built-in MCU. The sensor calibration algorithm is implemented with the built-in MCU and can supports up to 2nd order temperature drift compensation of offset and sensitivity for the sensor. It can also compensate the nonlinearity of sensor output up to 3rd order. The configuration parameters and coefficients for calibration are stored in the EEPROM.

The analog output module includes a 16-bit DAC and a flexible configurable output driver which can be configured to support analog output with several types of full-scale range and PWM output.

The power supply module includes a high-precision voltage reference, a sensor voltage driver, Over-voltage and Reverse-voltage protection block.

The NSA9260 supports OWI serial interface to do register writing and reading of configuration, calibration coefficients and data. Through the highly integrated and flexible interface, the NSA9260 only needs one wire to realize sensor calibration, field verification and full-scale range modification.

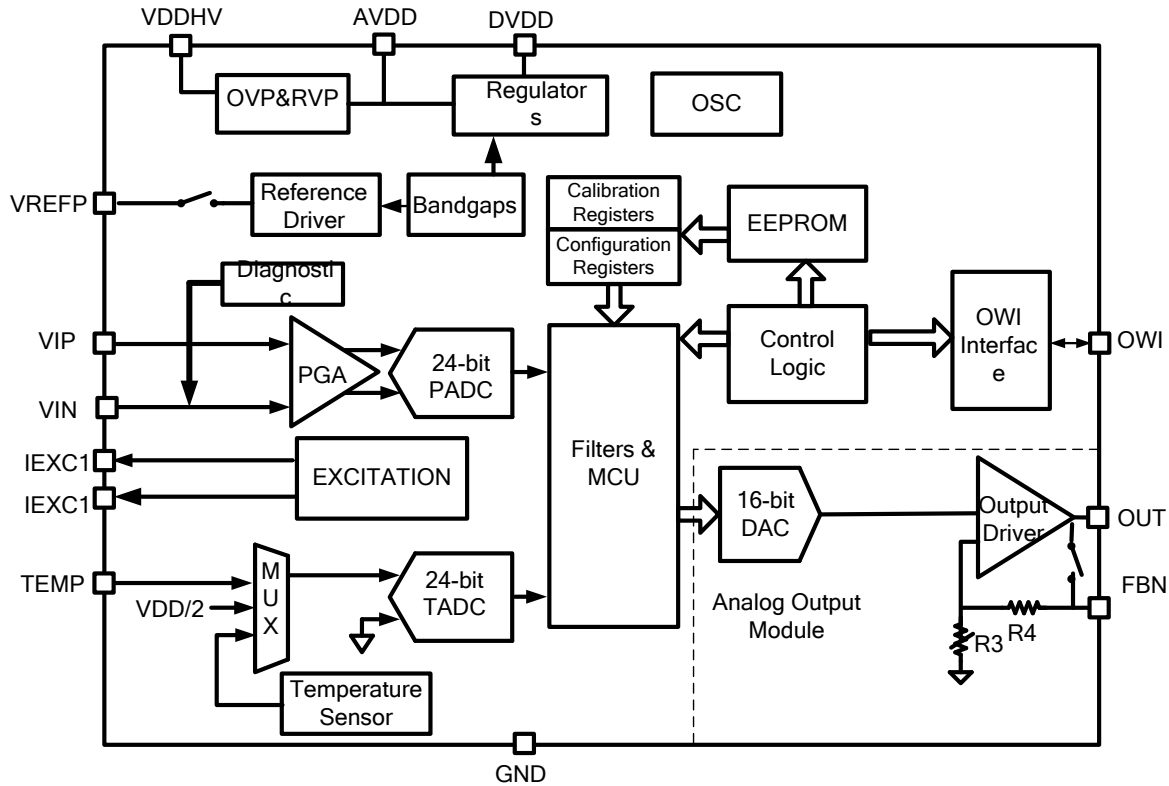


Figure 6.1 Block diagram of the NSA9260

6.2. Analog Front-end Module 1: Primary Signal Channel

The sensor signal measurement channel consists of an input gate circuit, an instrumentation PGA, a 24-bit high-precision Sigma Delta ADC (PADC), and a digital filter composition.

6.2.1. PGA+PADC

The PGA is a gain programmable instrumentation amplifier, which can be Configured to 1X, 2X, 4X, 6X, 8X, 16X, 24X, 32X, 48X, 64X, 96X, 128X, 192X, 256X. The NSA9260 has a built-in RFI filter for RFI immunity enhancement.

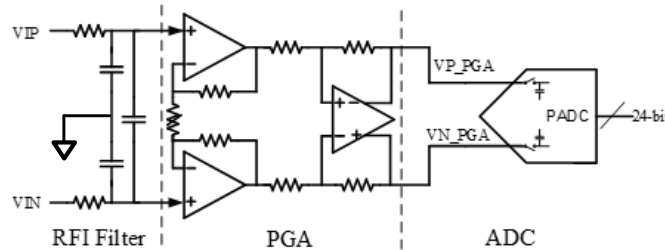


Figure 6.2 Primary signal channel (PGA+ADC)

The PADC performs analog-to-digital conversion. The output of the ADC is filtered digitally with 24-bit resolution. The reference voltage of the ADC is VREF, and the allowable differential input range is $\pm VREF/GAIN_P$. The PADC output can be expressed by the following equation:

$$PDATA_{RAW} = \frac{VIP - VIN}{VREF} * GAIN_P * 2^{23}$$

PDATA_{RAW} can be read out from ‘PDATA’ registers (Reg0x06-Reg0x08) only when ‘RAW_P’ is set to 1. Otherwise, the built-in MCU would calibrate the sensor using the calibration coefficients and temperature data stored in ‘TDATA’ and put the calibrated digital output of the primary channel to the ‘PDATA’ registers.

6.2.2. The Input Common-Mode Voltage of PGA

The PGA is of differential input and differential output. The output voltages of the PGA can be expressed as:

$$VP_PGA = V_{CMin} + GAIN_P * VDin/2$$

$$VN_PGA = V_{CMin} - GAIN_P * VDin/2$$

V_{CMin} and $VDin$ in the formula are common-mode voltage and differential voltage of the PGA input voltage. To avoid saturation of the amplifiers, both VP_PGA and VN_PGA should meet the following limitation:

$$AGND + 0.1V < VP(N)_PGA < AVDD - 0.1V$$

From above, the input common-mode voltage should satisfy the following limitation:

$$AGND + 0.1V + GAIN_P * VDin(max)/2 < V_{CMin} < AVDD - 0.1V - GAIN_P * VDin(max)/2$$

Besides, the input of the PGA amplifiers is PMOS transistor, so the PGA input should meet:

$$VIP(N) < AVDD - 1V$$

For voltage-driven bridge sensors, the common-mode voltage of its output is usually close to $VREF/2$. One can easily meet the limitation by choosing a proper 'GAIN_P' and make $VDin(max) < 0.8 * VREF / GAIN_P$. '0.8' here is considered to give some margin for the sensor sensitivity and the amplifier voltage swing. For current-driven sensors, more careful settings are needed to maximize the dynamic range of the PADC.

6.2.3. Digital Filter

The bandwidth and output data rate (ODR) of the digital filter can be set by 'ODR_P'. ODR can be set from 4.8 kHz to 5 Hz. The lower ODR, the lower noise the PADC output will have, in cost of slower time response. Table 6.1 shows the effective number of bits (ENOB) of the PADC output with different ODR_P settings. The relationship of ENOB with RMS noise is:

$$ENOB_{RMS} = 24 - \log_2(RMS_{ADC})$$

RMS_{ADC} is the RMS value of ADC output noise in LSB. The relationship between RMS ENOB ($ENOB_{RMS}$) and noise free ENOB ($ENOB_{NF}$) is shown as below:

$$ENOB_{NF} = ENOB_{RMS} - 2.7$$

Table 6.1 $ENOB_{RMS}$ of PADC under different ODR settings ($VREF = 4V$)

ODR (Hz)	GAIN														
	1	2	4	6	8	12	16	24	32	48	64	96	128	192	256
4800	17.4	17.5	17.3	17.3	17.3	17.1	17.3	17.2	17.1	17.0	16.8	16.4	16.0	15.6	15.1
2400	17.8	17.9	17.8	17.8	17.7	17.7	17.7	17.5	17.5	17.3	17.0	16.7	16.3	15.8	15.5
1200	18.2	18.1	18.0	18.2	18.1	18.1	18.1	17.9	17.9	17.6	17.4	17.1	16.6	16.2	15.8
600	18.5	18.4	18.5	18.5	18.3	18.4	18.3	18.3	18.1	18.1	17.8	17.5	17.1	16.6	16.2
300	19.2	19.0	19.2	19.1	19.1	19.1	19.1	18.9	18.8	18.5	18.4	18.0	17.5	17.1	16.7
150	20.2	20.4	20.1	20.1	20.2	20.1	19.9	19.6	19.6	19.3	19.0	18.5	18.1	17.6	17.2
75	20.7	20.9	20.6	20.6	20.5	20.5	20.5	20.3	20.2	19.8	19.5	19.1	18.7	18.2	17.8
37.5	21.3	21.4	21.0	21.2	21.1	21.1	20.9	20.8	20.7	20.3	20.0	19.6	19.2	18.7	18.3
20	21.8	21.8	21.5	21.6	21.6	21.6	21.5	21.3	21.1	20.7	20.5	20.0	19.6	19.1	18.7
10	21.8	21.7	21.7	21.7	21.6	21.6	21.5	21.4	21.1	20.7	20.4	20.0	19.7	19.1	18.7
5	22.2	22.2	22.0	22.1	22.1	22.0	21.9	21.8	21.5	21.2	20.8	20.5	20.1	19.6	19.2

6.3. Analog Module 2: Temperature Measurement Channel

The temperature measurement channel is to measure the working temperature of the sensor for the temperature compensation of the sensed signal. This channel works independently of the primary signal measurement channel. The NSA9260 supports both internal temperature sensor and external temperature sensor, selected by register bit 'EXT_TEMP' bit. The temperature sensor's output is digitized by a 24-bit ADC (TADC) and also filtered digitally. The ODR setting of the temperature measurement channel is same as the primary signal channel, set by 'ODR_T'. When the temperature difference between the sensor element and the NSA9260 chip is acceptable, internal temperature sensor can be used. Otherwise, a proper external temperature measurement scheme should be chosen, such as diode, RTD, NTC or the bridge resistor itself, etc. Through different 'RAW_T' setting, either the direct TADC data or the calibrated temperature data can be read from 'TDATA' registers.

6.3.1. Internal Temperature Sensor

The internal temperature sensor is factory calibrated, with its calibration coefficients stored at EEPROM registers reg0xC1, reg0xC2 and reg0xC3. When 'RAW_T' is set to 0 and 'GAIN_T' is set to 4X automatically, the NSA9260 can provide a temperature reading in degree Celsius, in the format of

$$T = TDATA/2^{16} + 25^{\circ}\text{C}$$

For example, 'TDATA = 0x1FF24B' corresponds to 56.95 °C. The relationship between the noise of the internal temperature sensor and 'ODR_T' setting is shown in Table 6.2.

Table 6.2 RMS noise of internal temperature sensor under different ODR_T

ODR (Hz)	2400	1200	600	300	150	75	37.5	18.75	10	5	2.5
RMS Noise in °C	0.0079	0.0060	0.0045	0.0038	0.0032	0.0020	0.0015	0.0011	0.0008	0.0008	0.0007

6.3.2. External Temperature Sensor

When external temperature sensor mode is selected, the temperature sensing signal input from the TEMP pin is buffered for TADC conversion. The reference voltage of the TADC is also VREF. The gain of the TADC can be 1X, 2X and 4X. The relationship between $TDATA_{RAW}$ and the temperature input is

$$TDATA_{RAW} = VTEMP * GAIN_T / VREF * 2^{23}$$

When RAW_T = 0, the built-in MCU calibrated the offset, sensitivity, and nonlinearity of the measured temperature signal. Please refer to application note NOVOSENSE provided for calibration description details. The external temperature sensing can be done in many ways, including RTD, diode and sensor bridge resistance itself. Figure 6.3 gives an example using a low TC drift resistor to sense the bridge resistance, which is usually proportional to the temperature of the sensor element. In case the bridge sensor is current driven, the bridge voltage can be used as temperature sensing input directly.

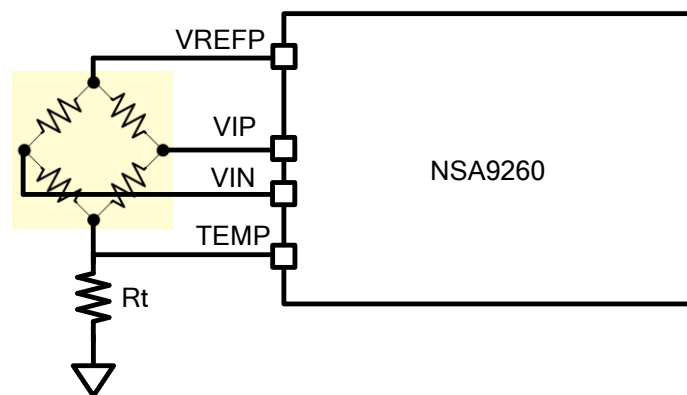


Figure 6.3 External temperature sensing using sensor bridge and a reference resistor

The output data rate of TADC can be set by 'ODR_T', similar as the primary signal channel. The relationship between ODR_T and the ENOB of TADC is shown in Table 6.3.

Table 6.3 ENOB of TADC under different ODR_T (External temperature sensor mode)

ODR_T(Hz)	ENOB		
	GAIN_T = 1	GAIN_T = 2	GAIN_T = 4
4800	17.2	17.0	16.4
2400	17.6	17.4	16.7
1200	18.0	17.6	16.7
600	18.3	17.8	16.9
300	18.6	18.0	17.1
150	19.0	18.4	17.5
75	18.9	18.1	17.1
37.5	19.4	18.2	17.6
20	19.8	18.9	18.0
10	19.8	19.1	18.0
5	20.4	19.4	18.3

6.4. Analog Output Stage

The analog output stage of the NSA9260 consists of a 16-bit DAC and an output buffer with feedback network. Through register configuration and external connection, the NSA9260 provides a lot of output modes such as absolute voltage output (0~5V, 0~3.3V, 0~1.2V), ratiometric voltage output (0~AVDD), and PWM output. The output mode of analog output stage can be configured by 'OUT_MODE' registers, which is an independent configuration from analog front-end ADC.

6.4.1. 16-bit DAC

The voltage output of the DAC is expressed by the following equation,

$$V_{OUT} = \frac{DAC_DATA < 15:0 >}{2^{16}} * VFSDAC$$

'DAC_DATA' stores the DAC input data in unsigned format. VFSDAC is the full-scale range of DAC, which is configured by 'DAC_REF'. When 'RAW_P' = 0, the 'DAC_DATA' is updated by the internal MCU with the calibrated output data.

6.4.2. Analog Output Clamping

The DAC full-scale range is clamped by the clamping voltage configured by 'CLAMP_HIGH' and 'CLAMP_LOW'.

The low clamping voltage is defined by the following equation,

$$V_{OUT_LOW} = \frac{CLAMP_LOW < 7:0 >}{2^9} * VFSDAC$$

The high clamping voltage is defined by the following equation,

$$V_{OUT_HIGH} = \left(1 - \frac{CLAMP_HIGH < 7:0 >}{2^9}\right) * VFSDAC$$

6.4.3. Voltage Output

When OUT_MODE = 3'b000, analog output stage is configured as voltage output mode. A class-AB output buffer is used to drive large load and the OUT pin and FBN pin should be shorted together as shown in Figure 6.4 (a). The OUT pin and FBN pin can also be shorted internally as to reduce the chip pin count by setting OUT_MODE = 3'b001, as shown in Figure 6.4 (b). The gain of output buffer is configured by 'DAC_REF' to provide several types of full-scale output range, such as absolute output (0~5V, 0~3.3V, 0~1.2V) and ratiometric output (0~AVDD), as listed in Table 6.4. The internal bandgap reference is used for absolute output.

Table 6.4 'DAC_REF' and output mode

DAC_REF<1:0>	Output Mode	Output Voltage Range
2'b00	Absolute	0~5V
2'b01	Absolute	0~3.3V
2'b10	Absolute	0~1.2V
2'b11	Ratiometric	0~AVDD

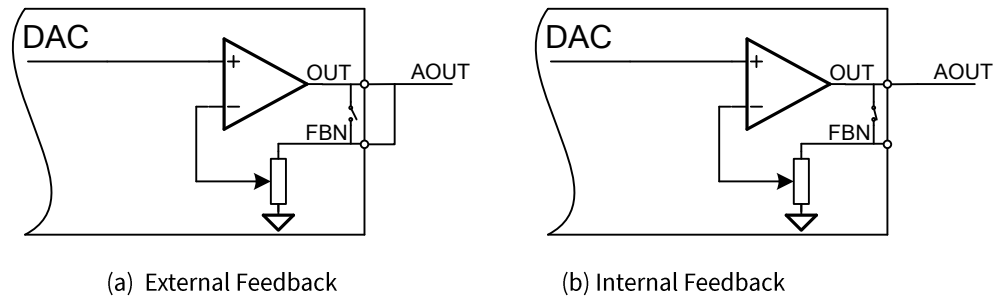


Figure 6.4 Configuration for voltage output mode

If Over-voltage or Reverse-voltage happens at AOUT pin, it can be protected with external feedback as shown in Figure 6.5. The OUT pin and FBN pin are connected to AOUT through 100 ohm and 1kohm resistor respectively.

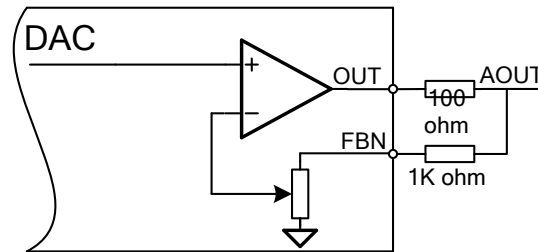


Figure 6.5 Configuration for voltage output mode with output protection

6.4.4.PWM

Both primary signal channel and temperature measurement channel support PWM output.

When 'OUT_MODE' = 3'b101, primary channel output data will present on the OUT pin in PWM format. The PWM carrier frequency is fixed at 600Hz, and the PWM output duty cycle is decided by DAC_DATA<15:4> with 12-bit resolution,

$$\text{PWM Duty Cycle of Primary Channel} = \text{DAC_DATA<15:4>} / 4096$$

When 'TOUT_EN' = 1 and the chip is not in OWI mode, the OWI pin is used as the output pin for Temperature Channel data in PWM format and the PWM output duty cycle is defined below:

$$\text{PWM Duty Cycle of Temperature Channel} = \text{TDATA<23:12>} / 4096$$

6.5. Power Management and Sensor Drive

The NSA9260 internally includes a precision bandgap reference with very low temperature drift, less than 0.2% during full temperature range (-40~125 °C). This reference voltage is used in the constant voltage or current driving circuits for clock generator and ADC/DAC etc.

6.5.1.Internal LDO

A 1.8V LDO is integrated in the NSA9260 to provide power supply for the internal digital circuits. A 100nF decoupling capacitor should be connected to DVDD pin externally.

6.5.2. Power on Reset

A POR block is integrated in the NSA9260 for power on reset and EEPROM loading. When $AVDD < 2.5V$, the chip is in reset state. After $AVDD > 2.5V$, the POR output is released and EEPROM is loaded afterwards. The POR circuits have 100mV hysteresis, i.e. the chip won't go into the reset state again until the AVDD is dropped as low as 2.4V.

6.5.3. Over-voltage and Reverse-voltage Protection

The NSA9260 integrates an Over-voltage and Reverse-voltage Protection on power supply. Over-voltage up to 28V and Reverse-voltage below -24V are protected.

6.6. Built-in MCU Core and Control Logics

6.6.1. Work Modes

Two Different work modes are supported by the NSA9260, command mode and active mode, which can be configured by the register 'CMD' (Reg0x30).

6.6.1.1. Command Mode

The command mode can be entered by writing the register 'CMD' with 0x00, which is used for configuring the chip outside. All the EEPROM registers (from Reg0xA1 - Reg0xD9) can be modified only in this mode.

6.6.1.2. Active Mode

The active mode is the default mode after powering up, which can also be entered by writing the register 'CMD' with 0x03. In this mode, the primary measurement channel and the temperature channel continuously update their measured values into the 'PDATA' or 'TDATA' registers, and the selected output mode will be activated simultaneously. When the register bit 'RAW_P/T' = 1, the ADC conversion results will be put into the 'PDATA' or 'TDATA' directly; otherwise, every time the primary measurement channel ADC conversion ends, the built-in MCU core performs sensor calibration flow once with the latest temperature value measured.

The shadow registers inside the NSA9260 can also guarantee a non-glitch reading by keeping the 'PDATA' and 'TDATA' registers stable during serial interface reading. Note that, the multiple bytes of one measured data should be read out together in one multi-byte serial interface reading command.

6.6.2. EEPROM

64 bytes EEPROM is contained in the NSA9260 to store the chip configurations and sensor calibration coefficients.

6.6.2.1. Loading

The contents of the EEPROM will be loaded into the EEPROM registers automatically after power up or soft-reset with the CRC checking. If the calculated CRC result does not match with what stored in the EEPROM, the 'CRC_ERROR' bit will be set and the analog output state will be decided according to the fault diagnostic and alarm configurations. Another status register bit 'LOADING_END' will be set after the loading completes.

6.6.2.2. Programming

EEPROM registers will not be programmed into the EEPROM directly after OWI writing. The contents of the EEPROM registers will be programmed into the EEPROM by the following sequence:

Set the register byte 'COMMAND' (Reg0x30) with 0x33 to enter EEPROM programming mode;

Write the register byte 'EE_PROG' (Reg0x6A) with 0x3E to start EEPROM programming.

During EEPROM programming, a new CRC check code will be generated according to the contents of the EEPROM registers and will be programmed to the EEPROM simultaneously. The content of the 'EE_PROG' register will come back to 0x00 automatically to indicate the programming is done. Another power cycle or soft-reset is needed to reload the EEPROM contents back to the EEPROM registers to check the programmed value.

6.6.2.3. Lock and Unlock

The EEPROM inside the NSA9260 can be locked by setting the 'EEPROM_LOCK' bit and programming it into the EEPROM. After locked, the EEPROM cannot be programmed again, and only a special EVA-kits provided by NOVOSENSE can unlock it.

6.6.3. Built-in MCU Core

The NSA9260 is integrated with a built-in MCU core, which performs signal processing, sensor calibration, EEPROM loading and programming etc. The MCU's program code is Pre-stored in the internal ROM, which cannot be modified by customers. Please contact NOVOSENSE if a customized MCU program code is needed.

6.6.4. Calibration

The calibration inside the NSA9260 is divided into two parts. The first is the DAC calibration, which can lower the offset and sensitivity error induced by the DAC block. The second is sensor calibration, which can compensate sensor offset, sensitivity, temperature drift up to 2nd order, and non-linearity up to the 3rd order. Please refer to application note NOVOSENSE provided.

6.7. Fault Detection and Alarm

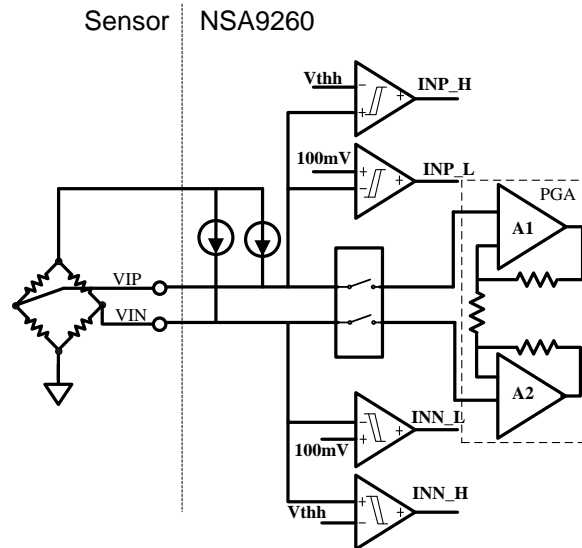


Figure 6.6 Diagnostic function

6.7.1. Fault Detection

Setting register bit 'BURNOUT_EN' = 1 enables the fault diagnostics. When diagnostics is enabled, a pair of 100nA burnout current sources is applied to the input of the primary signal channel. Four comparators will be activated to monitor the input voltages. Two comparators compare the input voltage to 100mV and the other two comparators compare the input voltages to upper limit level VTHH. VTHH depends on register bit 'VREF_DIS'. If 'VREF_DIS' = 0, VTHH = VEXT-100mV; otherwise VTHH = AVDD-1.1V. If any of the comparator's output is asserted, fault is detected and reported in the 'STATUS' register (reg0x02). The NSA9260 can detect the following sensor connection errors:

- VIP or VIN open
- Sensor Supply open
- VIP or VIN short to VDDHV
- VIP or VIN short to GND.

6.7.2. Alarm

Configured with high clamping and low clamping registers, the NSA9260 can alarm the following external connection errors and detect if the sensor output is out of range:

- Output short to VDD
- Output short to GND
- GND open (with pull-up resistor)

The NSA9260 is protected during the following abnormal conditions: Reverse Polarity between VDDHV and GND, Reverse Polarity between OUT and GND, Reverse Polarity between OUT and VDDHV.

7. Serial Interface

The OWI serial interface is supported in the NSA9260 to configure registers, program EEPROM and read measured data. When register bit 'OWI_WINDOW' = 0, the time between 10ms and 80ms after powering up is defined as the OWI entering window. If a specific 24 bits OWI entering pattern is detected via OWI pin in this window, the chip enters OWI communication mode, otherwise enters analog output mode (as shown in Figure 7.1).

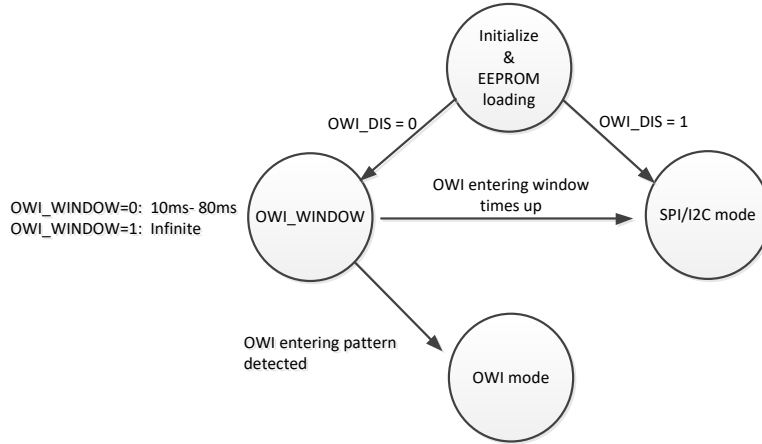


Figure 7.1 Definition of serial communication mode

7.1. OWI Pin Configuration

The OWI pin can be configured as open-drain or push-pull output by setting register 'OWI_PUSHPULL'. When 'OWI_PUSHPULL' = 0, OWI pin is open-drain output with the need of a pull-up resistor. When 'OWI_PUSHPULL' = 1, OWI pin is push-pull output.

7.2. Timing Spec

Table 7.1 OWI Timing Spec

Symbol	Description	Condition	Min.	Typ.	Max.	Unit
t_{period}	OWI bit period		30		4000	μs
t_{pulse_0}	Duty cycle for 0		1/8	1/4	3/8	t_{period}
t_{pulse_1}	Duty cycle for 1		5/8	3/4	7/8	t_{period}
t_{start}	Start low pulse time		20		4000	μs
t_{stop}	Stop condition time		2			t_{period}

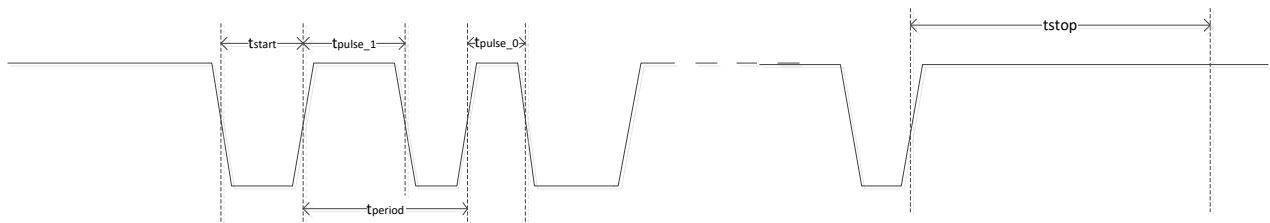


Figure 7.2 OWI Timing

7.3. Enter OWI Mode

If 'OWI_WINDOW' = 0, the time between 10ms and 80ms after powering up is OWI entering window. If a special 24 bits OWI entering pattern (0xB5A6C0, as shown below) is detected via OWI pin in this window, the chip enters OWI communication mode. Under this

setting, the OUT pin is disabled during the OWI window and OWI mode; the OWI pin and the OUT pin can be shorted together to support 3-wire sensor products.

If 'OWI_WINDOW' = 1, the OWI window's length becomes infinite, the OUT pin is activated during OWI window and OWI mode, and the OWI pin and OUT pin cannot be shorted together.

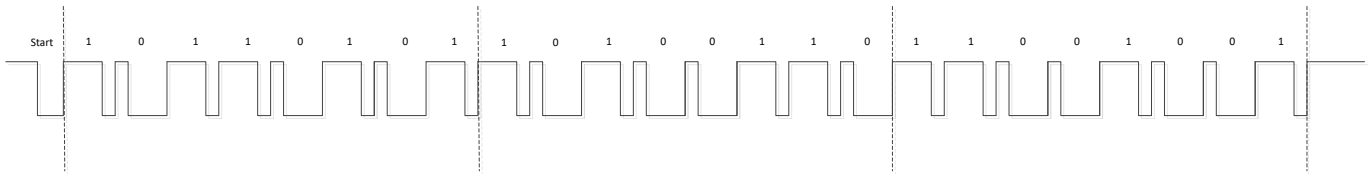


Figure 7.3 OWI Entering Pattern

In OWI communication, the bit period is determined by the period of the last bit of OWI entering pattern, and cannot be changed during the entire communication, so the bit period during OWI communication should keep the same as the OWI entering pattern.

7.4. OWI Protocol

The OWI protocol used is defined as follows:

a) Idle State

During inactivity of the bus, OWI line is pulled-up to high voltage level.

b) Start Condition

When OWI line is in idle state, a low pulse (return to high) with a pulse width between 20µs to 4ms indicates a start condition. Every command has to be initiated by a start condition sent by the master. The master can only generate the start condition when the OWI line is in idle state.

c) Stop Condition

After the write or read operation ends, the bus comes back to the idle state automatically. During any time of a transmission, the bus can be set back to the idle state by forcing the OWI line to reach a constant high or low voltage level for at least two times of the bit period (tBperiod).

d) Addressing

After the start condition, the master sends the addressing information, consisting of an 8-bit register address (MSB first), 2-bit byte number and a read/write bit (0-write, 1-read). The register address indicates which register you will write into or read from; the byte number indicates how many bytes will write/read continuously: 00: 1byte, 01: 2bytes, 10: 3bytes, 11: 4bytes; the read/write-bit indicates it a read operation (0) or write operation (1).

e) Write Operation

During transmission from master to slave (WRITE), the read/write bit is followed by 1/2/3/4 bytes (according to the byte NO. bits) transmitted data (MSB first), and the addressed register and follows will be refreshed to the written data after a stop condition.

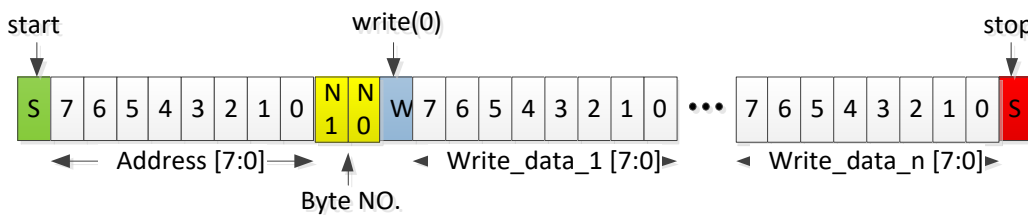


Figure 7.4 OWI Write Operation

f) Read Operation

During transmission from slave to master (READ), the master should set its OWI port as input after the read/write bit is sent, then the slave begins to transmit 1/2/3/4 bytes (according to the byte NO. bits) data (MSB first), which is the content in the addressed register and CRC data. Each data byte includes 8 bits of data and 2 bits of parity check code C1 and C0,

$$C1 = \text{Read_data}[7] \wedge \text{Read_data}[5] \wedge \text{Read_data}[3] \wedge \text{Read_data}[1];$$

$$C0 = \text{Read_data}[6] \wedge \text{Read_data}[4] \wedge \text{Read_data}[2] \wedge \text{Read_data}[0].$$

The master can check the transmission with the parity check code. After all data bytes transmitted, the slave goes back to idle state automatically.

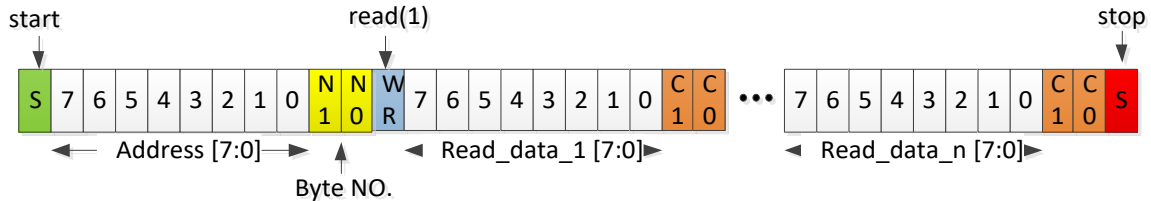


Figure 7.5 OWI Read Operation

7.5. Quit OWI Communication

Writing Reg0x61 with 0x5d during OWI mode can temporarily or permanently quit the OWI communication for output voltage or current measuring. The register byte ‘OWI_QUIT_CNT’ is used to set the quit time with the LSB = 50ms (0x00 means permanently quit), and the chip will be back into OWI mode again after the quit time’s up.

8. Application Note

8.1. Typical Application Circuit1

Function as absolute or ratiometric voltage output pressure sensor, with bridge driven by constant voltage source. Internal temperature sensor output is used for temperature compensation. For OWI communication, OWI can be separated with VOUT or shorted to VOUT pin.

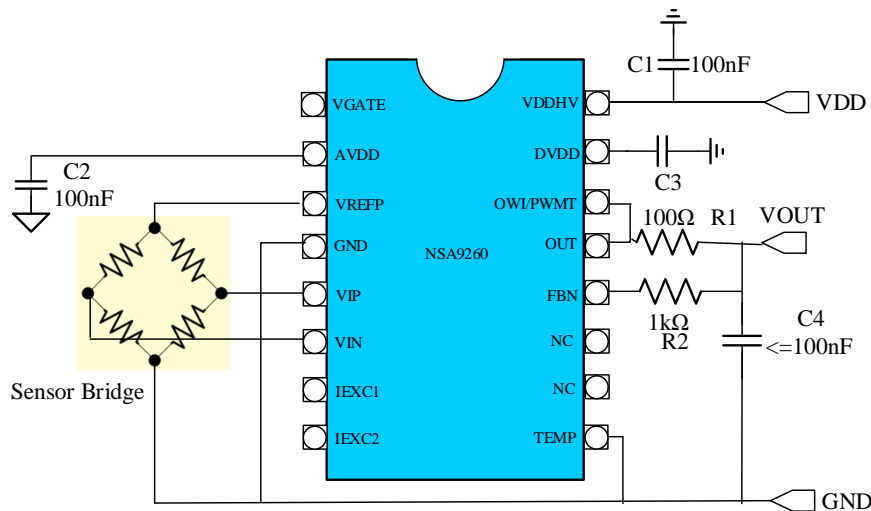


Figure8.1 Absolute/ratiometric voltage output with Over-voltage Protection

* R1 and R2 are used to limit the current of OUT pin when OUT pin sees Over-voltage or Reverse-voltage.

8.2. Typical Application Circuit2

External temperature sensor is used, while both temperature (PWM output through low pass filter) and pressure value are provided with analog output.

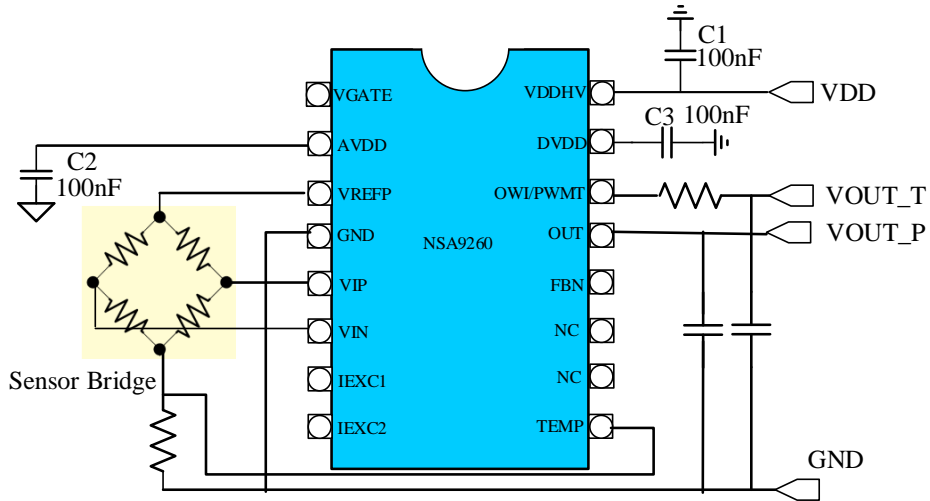


Figure 8.2 Dual analog voltage output

8.3. Typical Application Circuit3

Using JFET high-voltage power supply with an absolute output of 0-5V, VDD can support high-voltage input of 6.5V-36V.

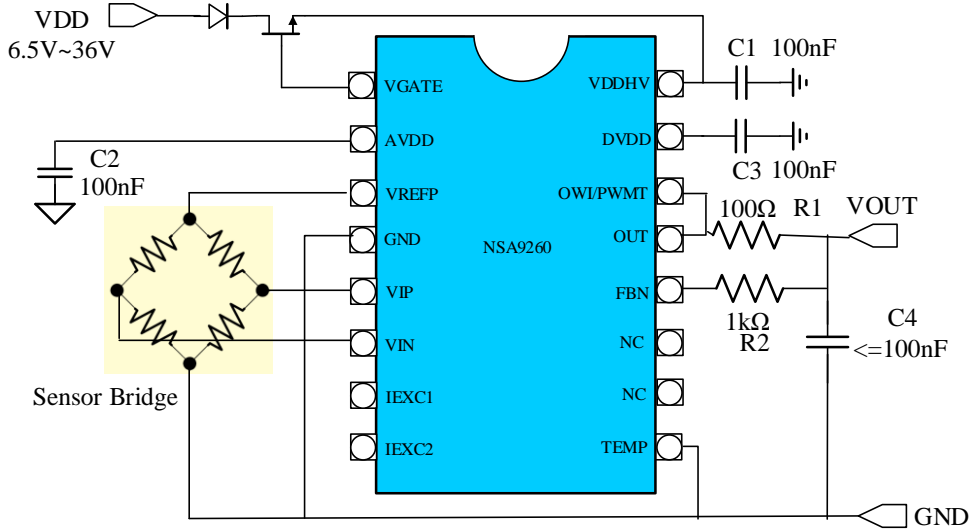


Figure 8.3 High voltage 0-5V using JFET

8.4. Typical Application Circuit4

Using VDDHV high-voltage power supply with an absolute output of 0-5V, VDD can support 5.5V-18V.

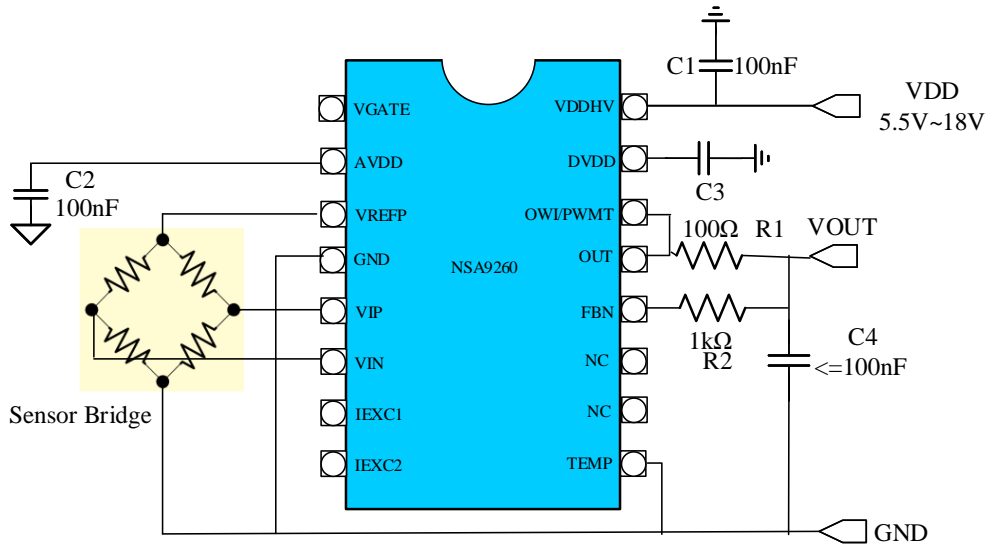
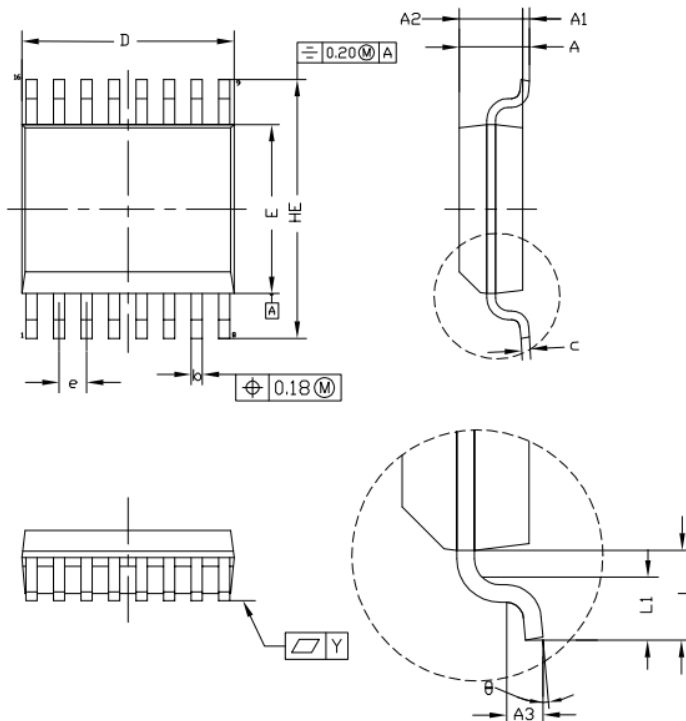


Figure 8.4 High voltage 0-5V using VDDHV Over-voltage protection function

9. Package Information



* CONTROLLING DIMENSION : MM

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	---	---	1.73	---	---	0.068
A1	0.10	---	0.25	0.004	---	0.010
A2	1.40	---	1.55	0.055	---	0.061
b	0.20	---	0.31	0.008	---	0.012
c	0.18	---	0.25	0.007	---	0.010
D	4.80	---	5.00	0.189	---	0.197
E	3.80	---	4.00	0.150	---	0.157
HE	5.80	---	6.20	0.228	---	0.244
e	0.635 bsc		0.025 bsc			
L	1.00 bsc		0.039 bsc			
L1	0.41	---	0.89	0.016	---	0.035
Y	---	0.09	---	---	0.004	---
A3	---	0.25	---	---	0.010	---
θ	0°	---	8°	0°	---	8°

Figure 9.1 SSOP16 package shape and dimension

10. Ordering Information

Part Number	Temperature	Vehicle specification level	MSL	Package Type	SPQ
NSA9260_SSOP	-40 to 150°C	AEC-Q100 Grade 0	1	SSOP16	2500

11. Tape and Reel Information

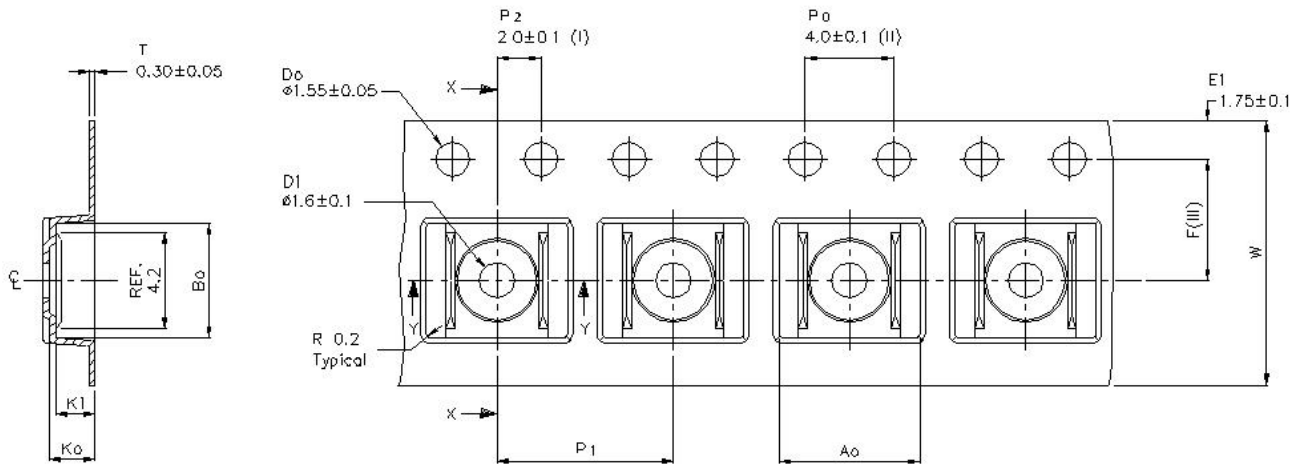
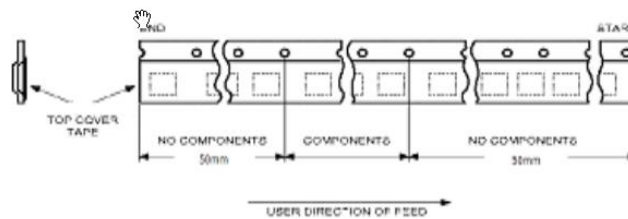


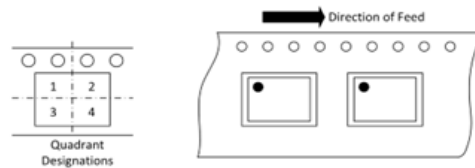
Figure 11.1 Tape/reel diagram for SSOP16

Part No.	Package type	A0 (mm)	B0 (mm)	K0 (mm)	K1 (mm)	F (mm)	P1 (mm)	W (mm)
NSA9260_SSOP	SSOP16	6.5 ± 0.1	5.3 ± 0.1	2.2 ± 0.1	1.9 ± 0.1	5.5 ± 0.1	8.0 ± 0.1	12.0 ± 0.3

There is no component at the head and the tail of each tape/reel, where the space is 50cm, as shown in the following figure,



Pin 1 is located at the first quadrant, as shown in the following figure,



12. Revision History

<i>Revision</i>	<i>Description</i>	<i>Date</i>
1.0	Initial Version	2017/1/6
1.1	1. Add OVP/RVP description in absolute maximum ratings table 2. Add tape/reel information	2017/3/21
1.2	Revised for uniform formatting	2023/7/20

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